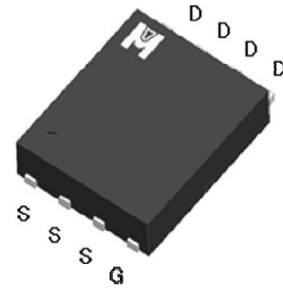
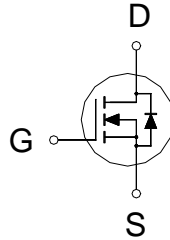


N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

|                     |               |
|---------------------|---------------|
| $BV_{DSS}$          | 40V           |
| $R_{DS(on)} (MAX.)$ | 1.6m $\Omega$ |
| $I_D$               | 100A          |



UIS, Rg 100% Tested

Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS                     |  | SYMBOL           | LIMITS     | UNIT             |
|--|--|------------------|------------|------------------|
| Gate-Source Voltage                            |  | $V_{GS}$         | $\pm 20$   | V                |
| Continuous Drain Current <sup>1</sup>          | $T_C = 25^\circ\text{C}$                             | $I_D$            | 100        | A                |
|  | $T_C = 100^\circ\text{C}$                            |                  | 100        |                  |
| Pulsed Drain Current <sup>2</sup>              |  | $I_{DM}$         | 400        |                  |
| Avalanche Current                              |  | $I_{AS}$         | 85         |                  |
| Avalanche Energy                               | $L = 0.1\text{mH}, I_D = 85\text{A}, R_G = 25\Omega$ | $E_{AS}$         | 361        | mJ               |
| Repetitive Avalanche Energy <sup>3</sup>       | $L = 0.05\text{mH}$                                  | $E_{AR}$         | 180        |                  |
| Power Dissipation                              | $T_C = 25^\circ\text{C}$                             | $P_D$            | 65         | W                |
|  | $T_C = 100^\circ\text{C}$                            |                  | 26         |                  |
| Operating Junction & Storage Temperature Range |  | $T_{j}, T_{stg}$ | -55 to 150 | $^\circ\text{C}$ |

100% UIS testing in condition of  $V_D = 30\text{V}, L = 0.1\text{mH}, V_G = 10\text{V}, I_L = 50\text{A}$ , Rated  $V_{DS} = 40\text{V}$  N-CH

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE               | SYMBOL          | TYPICAL | MAXIMUM | UNIT                        |
|----------------------------------|-----------------|---------|---------|-----------------------------|
| Junction-to-Case                 | $R_{\theta JC}$ |         | 1.9     | $^\circ\text{C} / \text{W}$ |
| Junction-to-Ambient <sup>4</sup> | $R_{\theta JA}$ |         | 50      |                             |

<sup>1</sup> Package Limited.

<sup>2</sup> Pulse width limited by maximum junction temperature.

<sup>3</sup> Duty cycle  $\leq 1\%$

<sup>4</sup>  $50^\circ\text{C} / \text{W}$  when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.



ELECTRICAL CHARACTERISTICS ( $T_J = 25\text{ }^\circ\text{C}$ , Unless Otherwise Noted)

| PARAMETER   | SYMBOL             | TEST CONDITIONS  | LIMITS  |      |           | UNIT       |
|---|--------------------|--|---|------|-----------|------------|
|   |                    |  | MIN   | TYP  | MAX       |            |
| <b>STATIC</b>   |                    |  |   |      |           |            |
| Drain-Source Breakdown Voltage  | $V_{(BR)DSS}$      | $V_{GS} = 0V, I_D = 250\mu A$                                | 40  |      |           | V          |
| Gate Threshold Voltage  | $V_{GS(th)}$       | $V_{DS} = V_{GS}, I_D = 250\mu A$                            | 1.0   | 2.0  | 3.0       |            |
| Gate-Body Leakage   | $I_{GSS}$          | $V_{DS} = 0V, V_{GS} = \pm 20V$                              |   |      | $\pm 100$ | nA         |
| Zero Gate Voltage Drain Current   | $I_{DSS}$          | $V_{DS} = 32V, V_{GS} = 0V$                                  |   |      | 1         | $\mu A$    |
|   |                    | $V_{DS} = 30V, V_{GS} = 0V, T_J = 125\text{ }^\circ\text{C}$ |   |      | 25        |            |
| On-State Drain Current <sup>1</sup>   | $I_{D(ON)}$        | $V_{DS} = 10V, V_{GS} = 10V$                                 | 100   |      |           | A          |
| Drain-Source On-State Resistance <sup>1</sup>   | $R_{DS(ON)}$       | $V_{GS} = 10V, I_D = 50A$                                    |   | 1.4  | 1.6       | m $\Omega$ |
|   |                    | $V_{GS} = 4.5V, I_D = 50A$                                   |   | 2.2  | 2.5       |            |
| Forward Transconductance <sup>1</sup>   | $g_{fs}$           | $V_{DS} = 5V, I_D = 50A$                                     |   | 65   |           | S          |
| <b>DYNAMIC</b>  |                    |  |   |      |           |            |
| Input Capacitance   | $C_{iss}$          | $V_{GS} = 0V, V_{DS} = 20V, f = 1MHz$                        |   | 6078 |           | pF         |
| Output Capacitance  | $C_{oss}$          |  |   | 1101 |           |            |
| Reverse Transfer Capacitance  | $C_{rss}$          |  |   | 250  |           |            |
| Gate Resistance   | $R_g$              | $V_{GS} = 15mV, V_{DS} = 0V, f = 1MHz$                       |   | 2.0  |           | $\Omega$   |
| Total Gate Charge <sup>1,2</sup>  | $Q_g(V_{GS}=10V)$  | $V_{DS} = 20V, V_{GS} = 10V,$<br>$I_D = 50A$                 |   | 82.9 |           | nC         |
|   | $Q_g(V_{GS}=4.5V)$ |  |   | 34.3 |           |            |
| Gate-Source Charge <sup>1,2</sup>   | $Q_{gs}$           |  |   | 27.2 |           |            |
| Gate-Drain Charge <sup>1,2</sup>  | $Q_{gd}$           |  |   | 4.3  |           |            |
| Turn-On Delay Time <sup>1,2</sup>   | $t_{d(on)}$        |  | $V_{DS} = 20V,$<br>$I_D = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$ |      | 15        |            |
| Rise Time <sup>1,2</sup>  | $t_r$              |  |   | 10   |           |            |
| Turn-Off Delay Time <sup>1,2</sup>  | $t_{d(off)}$       |  |   | 60   |           |            |
| Fall Time <sup>1,2</sup>  | $t_f$              |  |   | 15   |           |            |
| <b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_C = 25\text{ }^\circ\text{C}</math>)</b> |                    |  |   |      |           |            |
| Continuous Current  | $I_S$              |  |   |      | 100       | A          |
| Pulsed Current <sup>3</sup>   | $I_{SM}$           |  |   |      | 400       |            |
| Forward Voltage <sup>1</sup>  | $V_{SD}$           | $I_F = 50A, V_{GS} = 0V$                                     |   |      | 1.2       | V          |
| Reverse Recovery Time   | $t_{rr}$           | $I_F = 50A, di_F/dt = 100A / \mu S$                          |   | 90   |           | nS         |
| Reverse Recovery Charge   | $Q_{rr}$           |  |   |      | 125       |            |

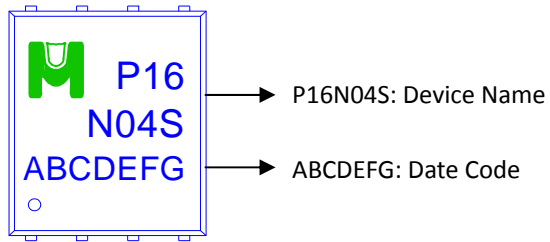
<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.

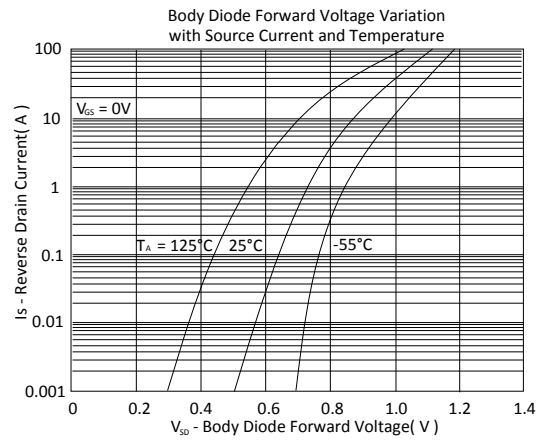
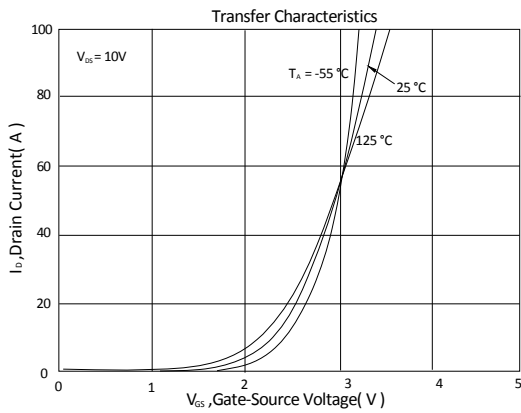
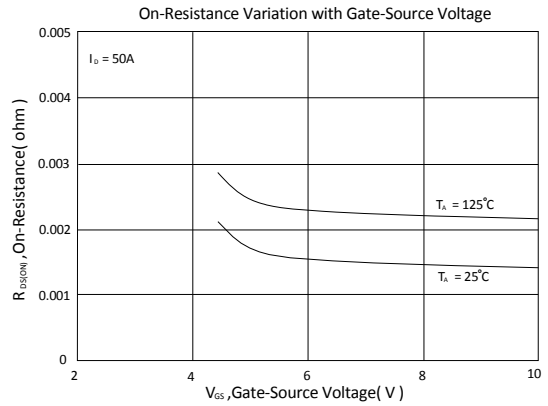
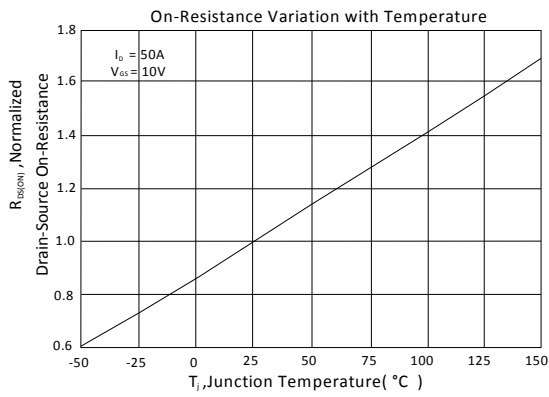
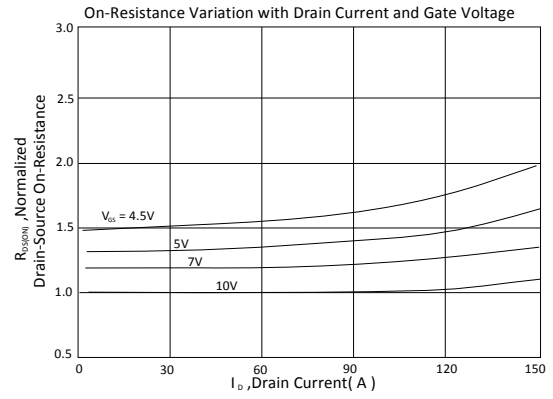
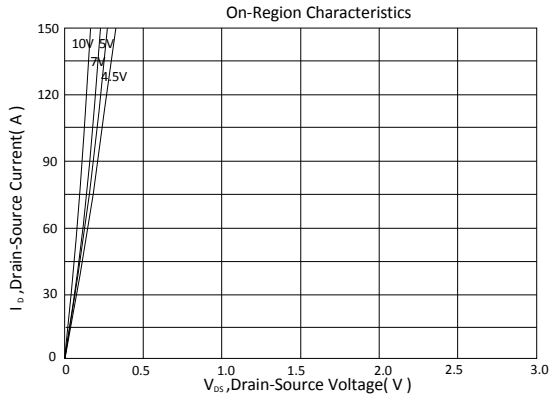
Ordering & Marking Information:

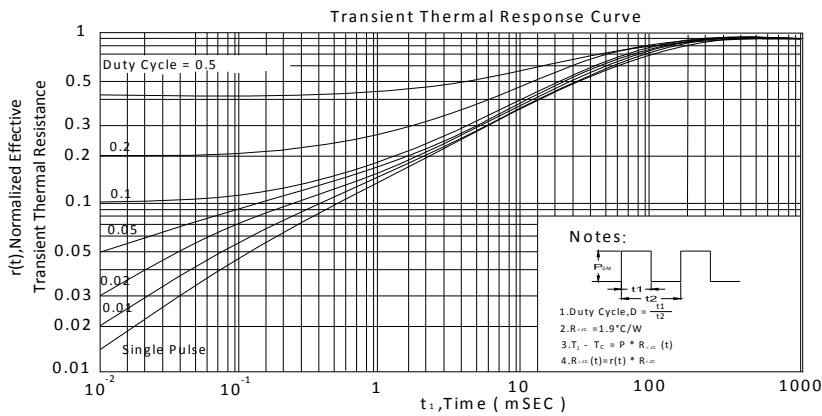
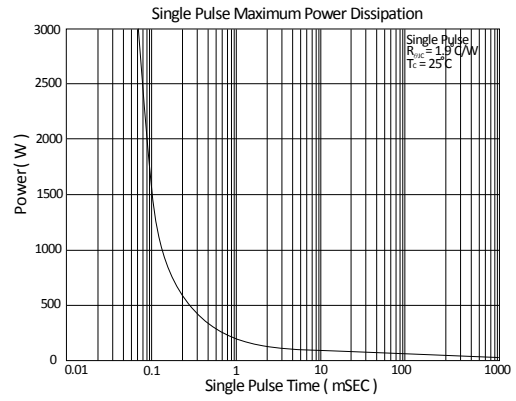
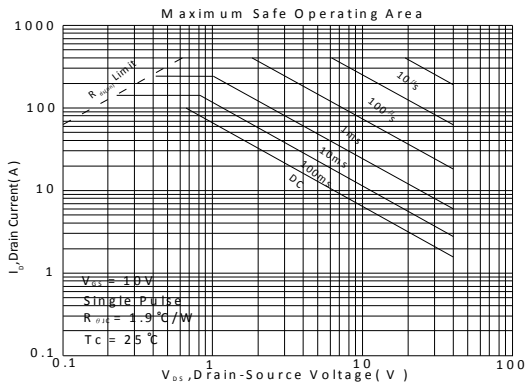
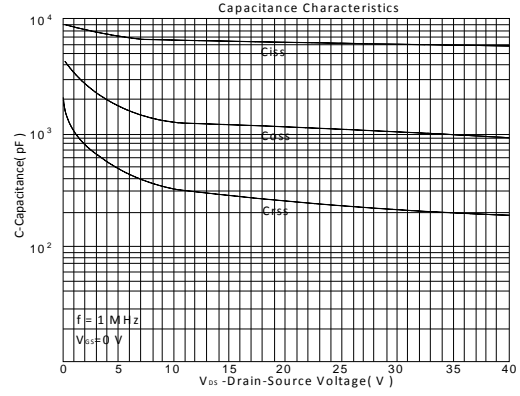
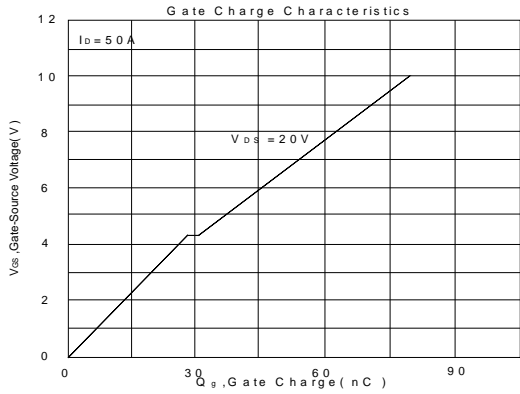
Device Name: EMP16N04HS for EDFN 5 x 6





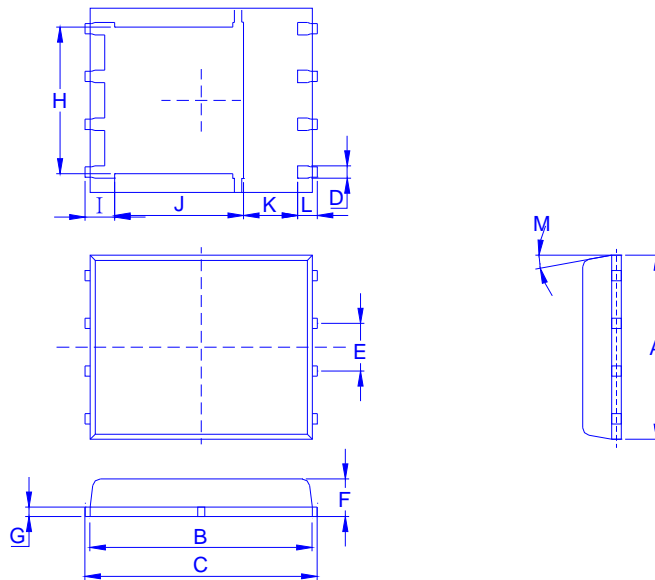
TYPICAL CHARACTERISTICS







Outline Drawing



Dimension in mm

| Dimension | A    | B    | C    | D    | E    | F    | G    | H    | I    | J    | K    | L    | M   |
|-----------|------|------|------|------|------|------|------|------|------|------|------|------|-----|
| Min.      | 4.80 | 5.50 | 5.90 | 0.3  |      | 0.85 | 0.15 | 3.67 | 0.41 | 3.00 | 0.94 | 0.45 | 0°  |
| Typ.      |      |      |      |      | 1.27 |      |      |      |      |      |      |      |     |
| Max.      | 5.30 | 5.90 | 6.15 | 0.51 |      | 1.20 | 0.30 | 4.54 | 0.85 | 3.92 | 1.7  | 0.71 | 12° |

Recommended minimum pads

